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ADHESIVE FILM FOR UNDERFILL AND
SEMICONDUCTOR DEVICE USING THE SAME
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FIG. 1

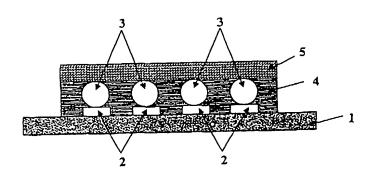


FIG. 2

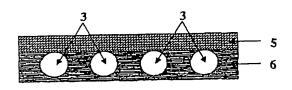


FIG. 3

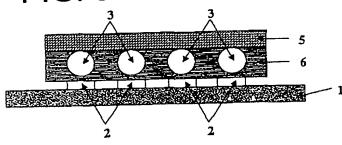
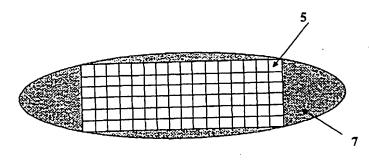


FIG. 4



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FIG. 5

